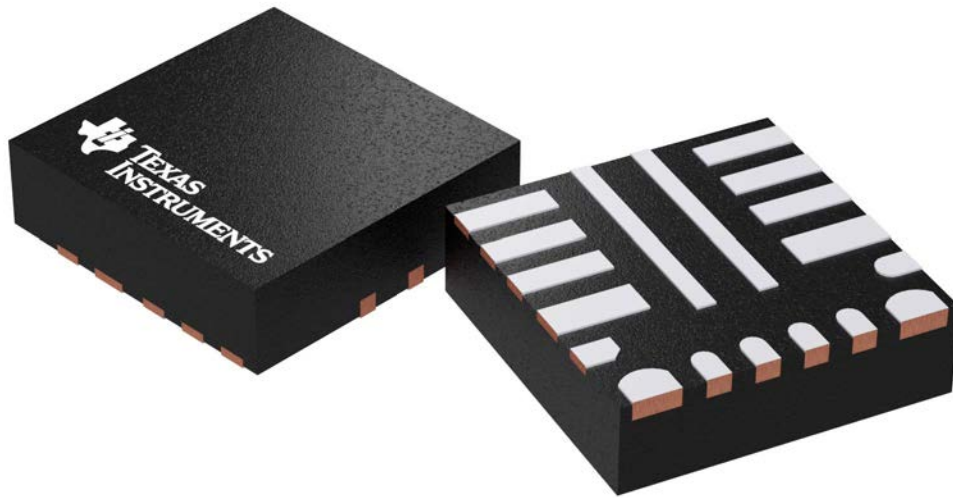


**RNV 18**

**GENERIC PACKAGE VIEW**

**VQFN-HR - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4223696-3/A

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